LNJ253W82RA

Hight Bright Surface Mounting Chip LED

SV (Side View) Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	PD	55	mW	
Forward current	I _F	20	mA	
Pulse forward current *	I _{FP}	60	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Lighting Color

• Red

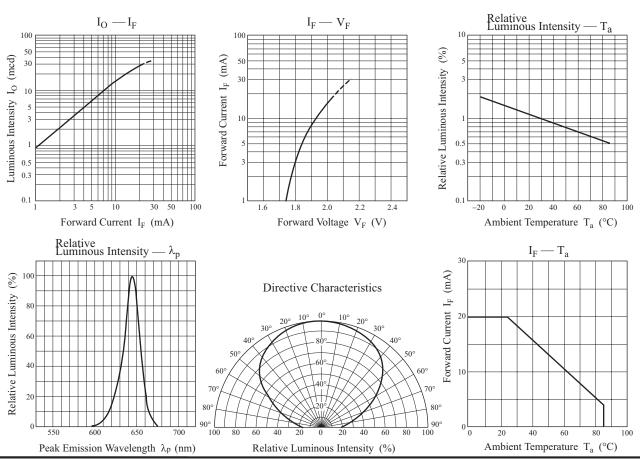
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	Io	$I_F = 10 \text{ mA}$	8.0	15.0	60.8	mcd
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		1.92	2.5	V
Dominant emission wavelength *2	λ _d	$I_F = 10 \text{ mA}$	620	630	640	nm
Peak emission wavelength	λ _P	$I_F = 10 \text{ mA}$		645		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		22		nm

Note) *1: Measurement tolerance: ±20%

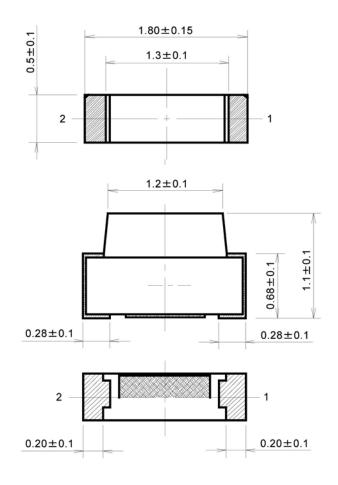
*2: Measurement tolerance: ±3 nm



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Package (Unit: mm)



• Pin name

1: Anode

2: Cathode

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